

# STARPOWER

SEMICONDUCTOR

**IGBT**

## GD25FFX120C5SP

**1200V/25A 6 in one-package**

### General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

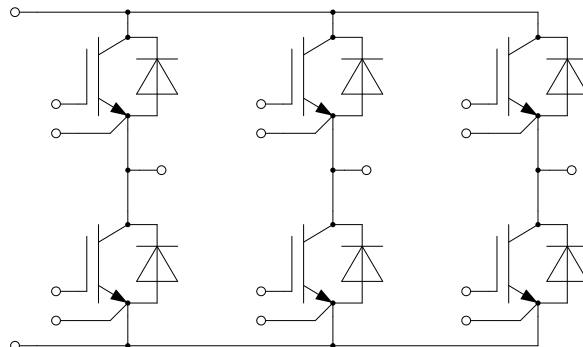
### Features

- Low  $V_{CE(sat)}$  Trench IGBT technology
- 10 $\mu$ s short circuit capability
- $V_{CE(sat)}$  with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

### Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

### Equivalent Circuit Schematic



**Absolute Maximum Ratings**  $T_C=25^{\circ}\text{C}$  unless otherwise noted**IGBT**

Symbol	Description	Value	Unit
$V_{CES}$	Collector-Emitter Voltage	1200	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$I_C$	Collector Current @ $T_C=25^{\circ}\text{C}$	50	A
	@ $T_C=100^{\circ}\text{C}$	25	A
$I_{CRM}$	Repetitive Peak Collector Current $t_p$ limited by $T_{vjop}$	50	A
$P_D$	Maximum Power Dissipation @ $T_{vj}=175^{\circ}\text{C}$	242	W

**Diode**

Symbol	Description	Value	Unit
$V_{RRM}$	Repetitive Peak Reverse Voltage	1200	V
$I_F$	Diode Continuous Forward Current	25	A
$I_{FRM}$	Repetitive Peak Forward Current $t_p$ limited by $T_{vjop}$	50	A

**Module**

Symbol	Description	Value	Unit
$T_{vjmax}$	Maximum Junction Temperature	175	$^{\circ}\text{C}$
$T_{vjop}$	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
$V_{ISO}$	Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$	2500	V

**IGBT Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=25\text{A}, V_{GE}=15\text{V}, T_{vj}=25^\circ\text{C}$		1.70	2.15	V
		$I_C=25\text{A}, V_{GE}=15\text{V}, T_{vj}=125^\circ\text{C}$		1.95		
		$I_C=25\text{A}, V_{GE}=15\text{V}, T_{vj}=150^\circ\text{C}$		2.00		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=1.00\text{mA}, V_{CE}=V_{GE}, T_{vj}=25^\circ\text{C}$	5.6	6.2	6.8	V
$I_{CES}$	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_{vj}=25^\circ\text{C}$			1.0	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_{vj}=25^\circ\text{C}$			400	nA
$R_{Gint}$	Internal Gate Resistance			0		$\Omega$
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		2.59		nF
$C_{res}$	Reverse Transfer Capacitance			0.07		nF
$Q_G$	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		0.19		$\mu\text{C}$

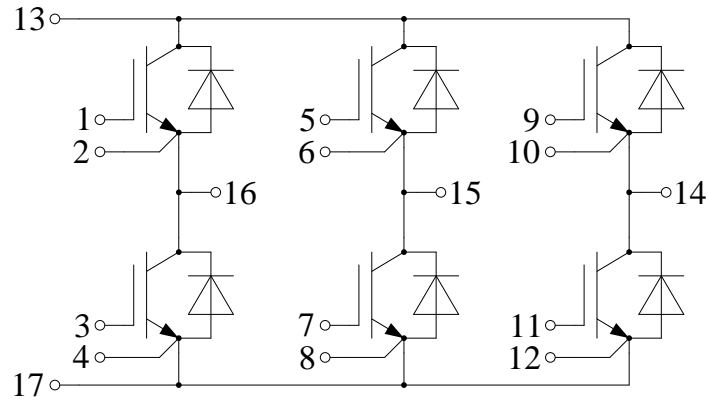
**Diode Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_F$	Diode Forward Voltage	$I_F=25\text{A}, V_{GE}=0\text{V}, T_{vj}=25^\circ\text{C}$		1.85	2.30	V
		$I_F=25\text{A}, V_{GE}=0\text{V}, T_{vj}=125^\circ\text{C}$		1.90		
		$I_F=25\text{A}, V_{GE}=0\text{V}, T_{vj}=150^\circ\text{C}$		1.95		

**Module Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

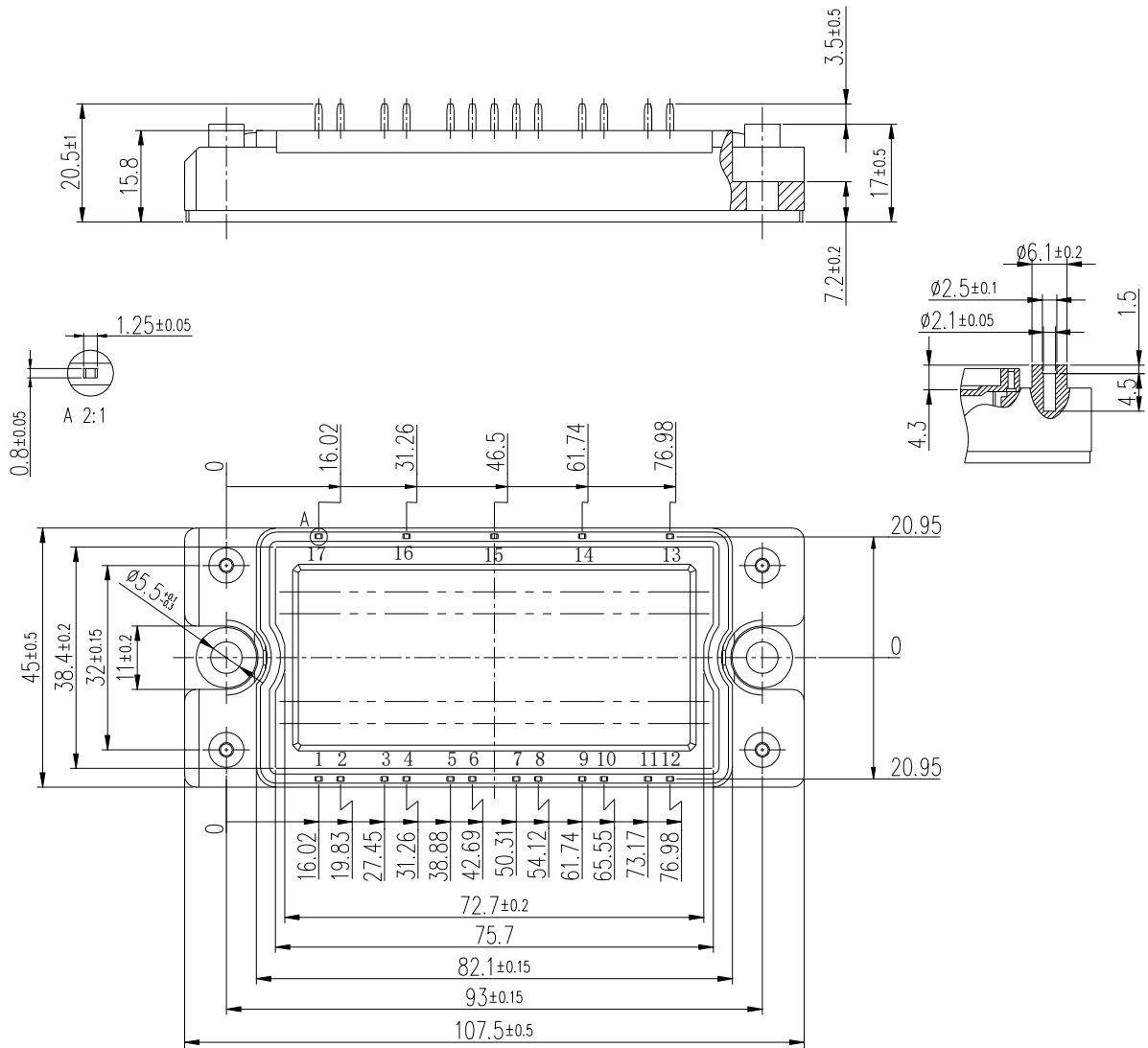
Symbol	Parameter	Min.	Typ.	Max.	Unit
$L_{CE}$	Stray Inductance		19		nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip		1.80		m $\Omega$
$R_{thJC}$	Junction-to-Case (per IGBT)			0.619	K/W
	Junction-to-Case (per Diode)			1.014	
M	Mounting Torque, Screw M5	3.0		6.0	N.m
G	Weight of Module		200		g

**Circuit Schematic**



**Package Dimensions**

Dimensions in Millimeters



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